

# MOS FIELD EFFECT TRANSISTOR 2SJ649

# SWITCHING P-CHANNEL POWER MOS FET

#### DESCRIPTION

The 2SJ649 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

#### **FEATURES**

• Low on-state resistance:

 $R_{DS(on)1} = 48 \text{ m}\Omega \text{ MAX.} (V_{GS} = -10 \text{ V}, \text{ ID} = -10 \text{ A})$ 

 $R_{\text{DS(on)2}}$  = 75 m $\Omega$  MAX. (Vgs = -4.0 V, ID = -10 A)

Low input capacitance:

 $C_{iss} = 1900 \text{ pF TYP.} (V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V})$ 

Built-in gate protection diode

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^{\circ}C$ )

Drain to Source Voltage (VGs = 0 V)	Vdss	-60	V
Gate to Source Voltage ( $V_{DS} = 0 V$ )	Vgss	<b>∓20</b>	V
Drain Current (DC) (Tc = 25°C)	D(DC)	∓20	А
Drain Current (pulse) <sup>Note1</sup>	D(pulse)	<b>∓70</b>	А
Total Power Dissipation (Tc = 25°C)	Рт	25	W
Total Power Dissipation ( $T_A = 25^{\circ}C$ )	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	-20	А
Single Avalanche Energy Note2	Eas	40	mJ

#### ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ649	Isolated TO-220

(Isolated TO-220)



#### **Notes 1.** PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1%

**2.** Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = -20  $\rightarrow$  0 V

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ELECTRICAL CHARACTERISTICS (TA = 25°C)

Characteristics	Symbol	Test Condtions	MIN.	TYP.	MAX.	Unit
Zero Gate Voltage Drain Current	ldss	Vds = -60 V, Vgs = 0 V			-10	μA
Gate Leakage Current	lgss	$V_{GS} = \mp 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			∓10	μA
Gate Cut-off Voltage	VGS(off)	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-1.5	-2.0	-2.5	V
Forward Transfer Admittance Note	yfs	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -10 \text{ A}$	10	20		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = −10 V, Id = −10 A		38	48	mΩ
	RDS(on)2	$V_{GS} = -4.0 \text{ V}, \text{ I}_{D} = -10 \text{ A}$		47	75	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		1900		pF
Output Capacitance	Coss	Vgs = 0 V		350		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		140		pF
Turn-on Delay Time	td(on)	$V_{DD} = -30 \text{ V}, \text{ Id} = -10 \text{ A}$		10		ns
Rise Time	tr	Vgs = -10 V		10		ns
Turn-off Delay Time	td(off)	Rg = 0 Ω		73		ns
Fall Time	tr			17		ns
Total Gate Charge	QG	$V_{DD} = -48 V$		38		nC
Gate to Source Charge	Q <sub>GS</sub>	Vgs = -10 V		7		nC
Gate to Drain Charge	Qgd	ID = -20 A		10		nC
Body Diode Forward Voltage Note	VF(S-D)	IF = 20 A, VGS = 0 V		0.95		V
Reverse Recovery Time	trr	IF = 20 A, VGS = 0 V		49		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		100		nC

**Note** Pulsed: PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

#### TEST CIRCUIT 2 SWITCHING TIME

≶R∟ 1

Vdd

Vgs

Wave Form

Vos Wave Form Vgs (-)

VDS (-)

Vds

0

td(on)

ton

0 10%

90%

90%

tf

toff

Vgs

10% 10%

tr td(off)

D.U.T.

RG

τ

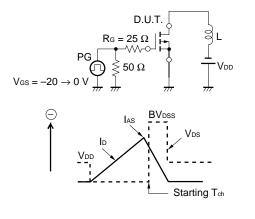
Duty Cycle  $\leq 1\%$ 

 $\tau = 1 \, \mu s$ 

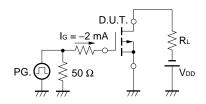
PG

Vgs (-)

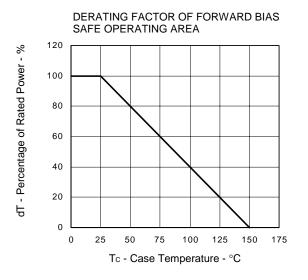
0.

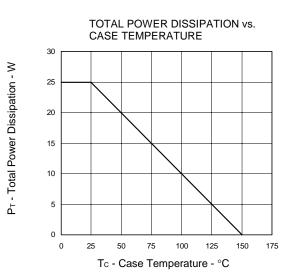


#### TEST CIRCUIT 3 GATE CHARGE

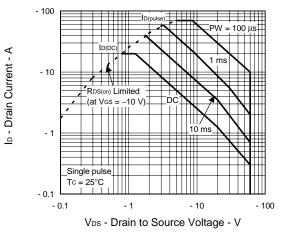


### TYPICAL CHARACTERISTICS ( $T_A = 25^{\circ}C$ )

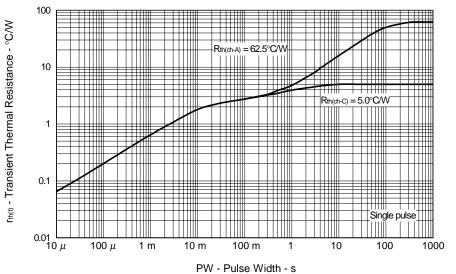




FORWARD BIAS SAFE OPERATING AREA



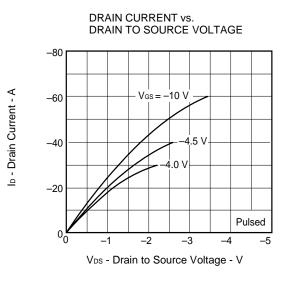




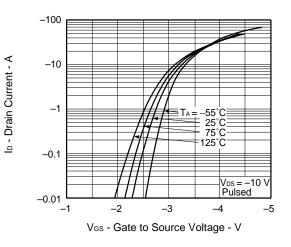
Data Sheet D16332EJ1V0DS

-4.0

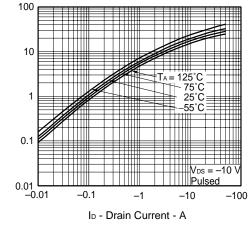
V<sub>GS(off)</sub> - Gate Cut-off Voltage - V

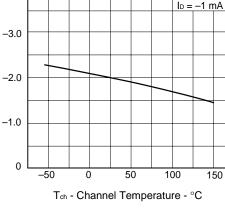


FORWARD TRANSFER CHARACTERISTICS



FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



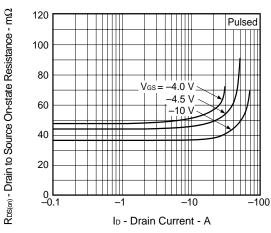


GATE CUT-OFF VOLTAGE vs.

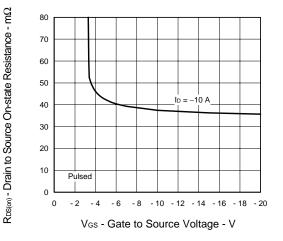
 $V_{DS} = -10 V$ 

CHANNEL TEMPERATURE

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

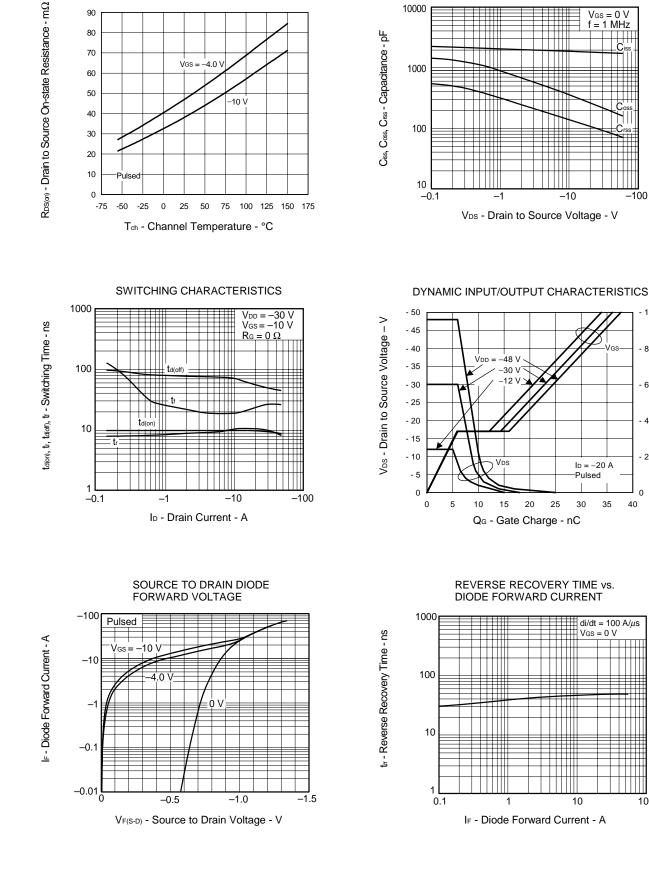


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



 $\mid$  yrs  $\mid$  - Forward Transfer Admittance - S

10000



NEC

90

80

70

DRAIN TO SOURCE ON-STATE RESISTANCE vs.

CHANNEL TEMPERATURE

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

2SJ649

V<sub>GS</sub> = 0 V f = 1 MHz

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- 10

- 8

- 6

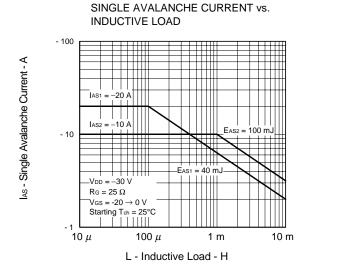
- 4

- 2

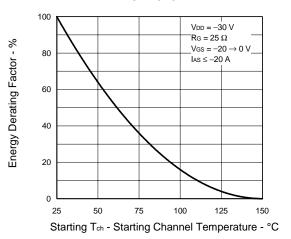
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Vgs - Gate to Source Voltage - V

100

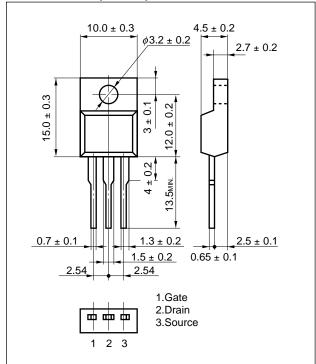


#### SINGLE AVALANCHE ENERGY DERATING FACTOR

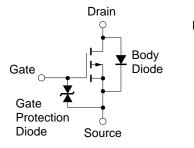


## PACKAGE DRAWING (Unit: mm)

#### Isolated TO-220 (MP-45F)



#### EQUIVALENT CIRCUIT



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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